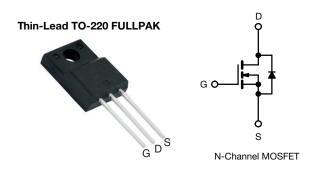
RoHS

COMPLIANT

HALOGEN FREE



E Series Power MOSFET with Fast Body Diode



PRODUCT SUMMA	RY	
V _{DS} (V) at T _J max.	700)
R _{DS(on)} max. (Ω) at 25 °C	V _{GS} = 10 V	0.156
Q _g max. (nC)	122	2
Q _{gs} (nC)	17	
Q _{gd} (nC)	36	
Configuration	Sing	le

FEATURES

- Fast body diode MOSFET using E series technology
- Reduced t_{rr}, Q_{rr}, and I_{RRM}
- Low figure-of-merit (FOM) R_{on} x Q_q
- Low input capacitance (Ciss)
- Low switching losses due to reduced Q_{rr}
- Ultra low gate charge (Q_g)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- · Consumer and computing
 - ATX power supplies
- Industrial
 - Welding
 - Battery chargers
- Renewable energy
 - Solar (PV inverters)
- Switch mode power supplies (SMPS)
- · Applications using the following topologies
 - LCC
 - Phase shifted bridge (ZVS)
 - 3-level inverter
 - AC/DC bridge

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free	SiHA24N65EF-E3
Lead (Pb)-free and halogen-free	SiHA24N65EF-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage	ource voltage V _{DS} 650		V			
Gate-source voltage		V_{GS}	± 30	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \		
Continuous drain surrent /T 150 °C) 6	V _{GS} at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	_	24		
Continuous drain current (T _J = 150 °C) ^e	VGS at 10 V	T _C = 100 °C	Ι _D	15	Α	
Pulsed drain current ^a			I _{DM}	65		
inear derating factor			0.31	W/°C		
Single pulse avalanche energy ^b		E _{AS}	691	mJ		
Maximum power dissipation		P _D	39	W		
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	T _J = 125 °C		-11//-1+	70	1//	
Reverse diode dV/dt ^d	•		dV/dt	50	- V/ns	
Soldering recommendations (peak temperature) ^c	ndations (peak temperature) c for 10 s 300		°C			
Mounting torque	ng torque M3 screw		0.6	Nm		

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature b. $V_{DD}=50$ V, starting $T_J=25$ °C, L = 28.2 mH, $R_g=25$ Ω , $I_{AS}=7$ A c. 1.6 mm from case

- d. $I_{SD} \le I_D$, dI/dt = 900 A/ μ s, starting $T_J = 25$ °C
- Limited by maximum junction temperature



Vishay Siliconix

THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	65	°C/W
Maximum junction-to-case (drain)	R_{thJC}	-	3.2	G/ V V

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		-		•			
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		650	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, I _D = 1 mA		0.68	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	- V _{GS} , I _D = 250 μA	2	-	4	V
		V _{GS} = ± 20 V		-	-	± 100	nA
Gate-source leakage	I _{GSS}	,	V _{GS} = ± 30 V	-	-	± 1	μΑ
7		V _{DS} =	= 520 V, V _{GS} = 0 V	-	-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 520 V	', V _{GS} = 0 V, T _J = 125 °C	-	-	500	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 12 A	-	0.13	0.156	Ω
Forward transconductance	9 _{fs}	V _{DS}	= 30 V, I _D = 12 A	-	7.2	-	S
Dynamic		-					
Input capacitance	C _{iss}		V _{GS} = 0 V,		2774	-	
Output capacitance	C _{oss}	╡ ,	$V_{DS} = 100 \text{ V},$	-	128	-	1
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	4	-	pF
Effective output capacitance, energy related ^a	$C_{o(er)}$	$V_{DS} = 0 \text{ V to } 520 \text{ V}, V_{GS} = 0 \text{ V}$		-	96	-	
Effective output capacitance, time related ^b	C _{o(tr)}			-	333	-	
Total gate charge	Qg		-	81	122		
Gate-source charge	Q_{gs}	V _{GS} = 10 V	$I_D = 12 \text{ A}, V_{DS} = 520 \text{ V}$	-	17	-	nC
Gate-drain charge	Q _{gd}	7		-	36	-	
Turn-on delay time	t _{d(on)}	V _{DD} = 520 V, I _D = 12 A,		-	24	48	
Rise time	t _r			-	34	68	
Turn-off delay time	t _{d(off)}	V _{GS} =	$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		80	120	ns
Fall time	t _f	1		-	46	92	
Gate input resistance	R_g	f = 1 MHz, open drain		0.2	0.5	1.0	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	24	
Pulsed diode forward current	I _{SM}			-	-	65	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 12 A, V _{GS} = 0 V		-	0.9	1.2	V
Reverse recovery time	t _{rr}		., 25 0, 15 - 12 1, 145 - 0		151	288	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 12 \text{ A},$ $dI/dt = 100 \text{ A/µs}, V_R = 400 \text{ V}$		-	0.9	2.1	μC
Reverse recovery current	I _{RRM}				13	_	Α

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

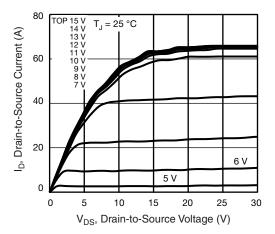


Fig. 1 - Typical Output Characteristics

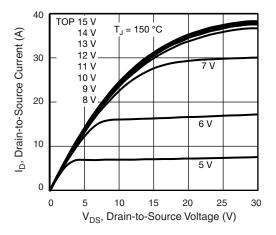


Fig. 2 - Typical Output Characteristics

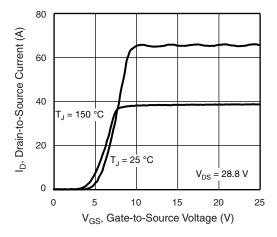


Fig. 3 - Typical Transfer Characteristics

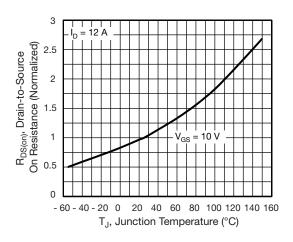


Fig. 4 - Normalized On-Resistance vs. Temperature

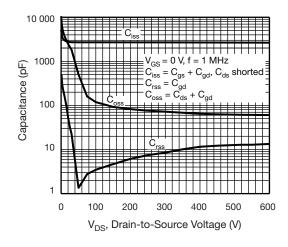


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

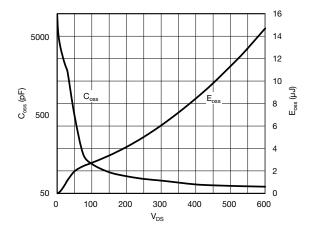


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}



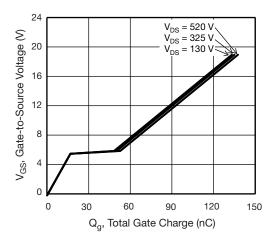


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

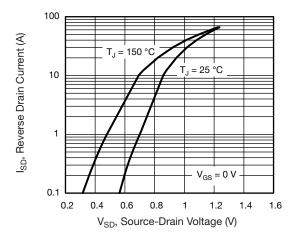


Fig. 8 - Typical Source-Drain Diode Forward Voltage

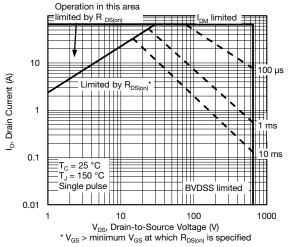


Fig. 9 - Maximum Safe Operating Area

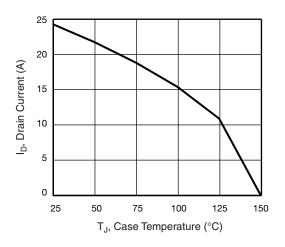


Fig. 10 - Maximum Drain Current vs. Case Temperature

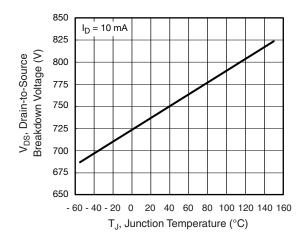


Fig. 11 - Temperature vs. Drain-to-Source Voltage



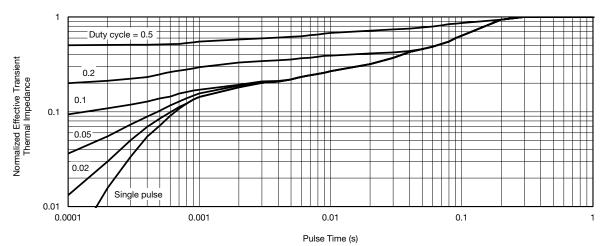


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

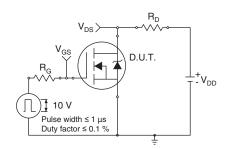


Fig. 13 - Switching Time Test Circuit

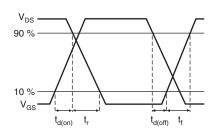


Fig. 14 - Switching Time Waveforms

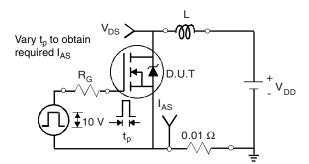


Fig. 15 - Unclamped Inductive Test Circuit

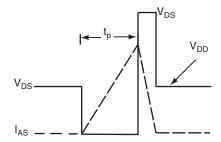


Fig. 16 - Unclamped Inductive Waveforms

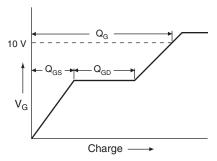


Fig. 17 - Basic Gate Charge Waveform

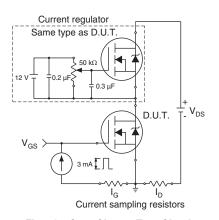
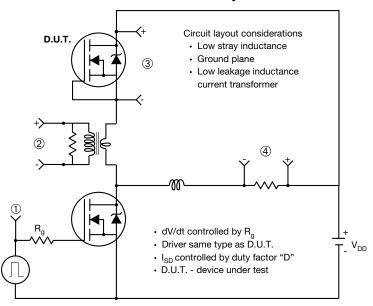


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



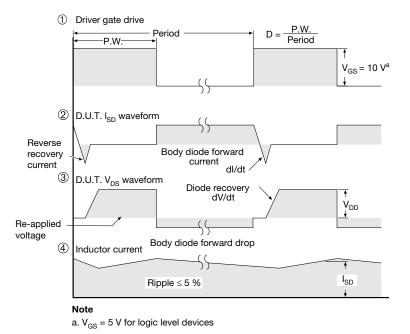


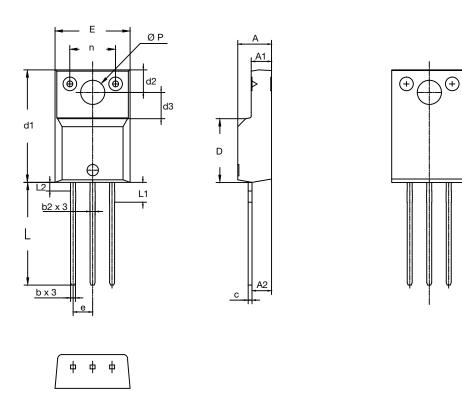
Fig. 19 - For N-Channel

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TO-220 FULLPAK Thin Lead



SYMBOL	DIMENSIONS				
	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.30	4.70	0.169	0.185	
A1	2.50	2.90	0.098	0.114	
A2	2.50	2.70	0.098	0.106	
b	0.60	0.80	0.024	0.031	
b2	0.60	0.90	0.024	0.035	
С	=	0.60	-	0.024	
D	8.30	8.70	0.327	0.342	
d1	14.70	15.30	0.579	0.602	
d2	2.90	3.10	0.114	0.122	
d3	3.40	3.60	0.134	0.142	
E	9.70	10.30	0.382	0.406	
е	2.50	2.70	0.098	0.106	
L	13.40	13.80	0.528	0.543	
L1	2.50	2.80	0.098	0.110	
L2	-	1.20	-	0.047	
n	6.05	6.15	0.238	0.242	
ØΡ	3.00	3.40	0.118	0.134	

Revision: 12-Sep-16 1 Document Number: 62649



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